- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

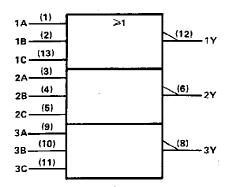
These devices contain three independent 3-input NOR gates.

The SN5427 and SN54LS27 are characterized for operation over the full military temperature range of $-55\,^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$. The SN7427 and SN74LS27 are characterized for operation from 0 $^{\circ}\text{C}$ to 70 $^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

11	NPUT	s	OUTPUT		
A	В	С	Υ_		
Н	х	×	Ļ		
Х	Н	х	L		
Х	X	Н	L		
L	L	L	Н		

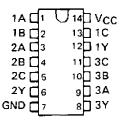
logic symbol †



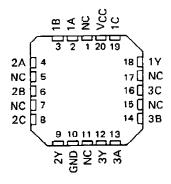
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5427, SN54LS27...J OR W PACKAGE SN7427...N PACKAGE SN74LS27...D OR N PACKAGE (TOP VIEW)

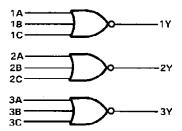


SN54LS27 . . . FK PACKAGE (TOP VIEW)



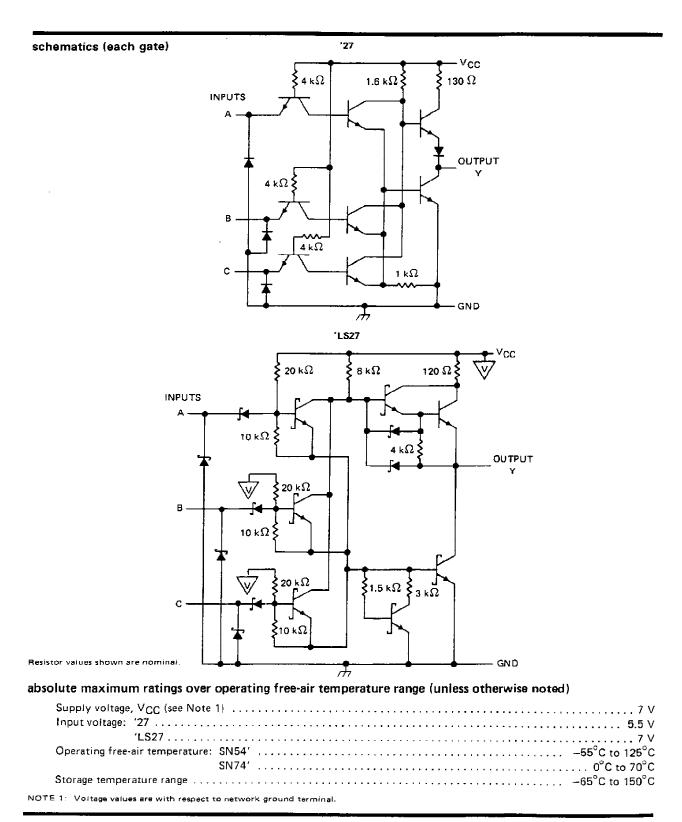
NC - No internal connection

logic diagram



positive logic

 $Y = \overline{A + B + C}$ or $Y = \overline{A} \cdot \overline{B} \cdot \overline{C}$



recommended operating conditions

			SN5427			SN7427		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VGC	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage	2	•		2			٧
VIL	Low-level input voltage			8,0			0.8	V
Іон	High-level output current			- 0.8			- 0.8	mΑ
lo L	Low-level output current			16			16	mΑ
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN5427				SN7427	,	UNIT
PANAMETER		MIN	MIN TYP \$	MAX	MIN	TYP ‡	MAX	UNII		
٧ıĸ	V _{CC} = MIN,	I ₁ = - 12 mA				- 1.5			- 1.5	٧
VOH	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = -0.8 mA	2.4	3.4		2,4	3.4		V
٧٥٢	VCC = MIN,	V _{IH} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
tj	V _{CC} = MAX,	V ₁ = 5.5 V				1			1	mA
ήн	V _{CC} = MAX,	V ₁ = 2.4 V			•	40			40	μΑ
l _{l L}	VCC = MAX,	V1 = 0.4 V	-			- 1.6			1.6	mA
108 §	V _{CC} = MAX			- 20		- 55	- 18		- 55	mA
Іссн	VCC = MAX,	VI = 0 V			10	16		10	16	mA
(CCL	V _{CC} = MAX,	See Note 2			16 ,	26	-	16	26	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONI	MIN	TYP	MAX	UNIT	
t _{PLH}	A, B or C	v	R _L = 400 Ω,	C 16 nE		10	15	ns
tpHL	A, 8 01 C	1	11[- 400 32,	CL = 15 pF		7	11	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § Not more than one output should be shorted at a time.

SN54LS27, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES

recommended operating conditions

•		S	SN54LS27			SN74LS27		
_		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			٧
VIL	Low-level input voltage			0.7			0.8	٧
Іон	High-level output current			- 0.4			- 0.4	mΑ
loL	Low-level output current			4			В	mA
Тд	Operating free-air temperature	– 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONCUTIONS A				SN54LS27			SN74LS27		
PARAMETER		TEST CONDITIONS †			TYP‡	MAX	MIN	TYP ‡	MAX	UNIT
۷ıĸ	V _{CC} = MIN,	I _I = - 18 mA	•			- 1.5			— 1.5	>
Voн	V _{CC} - MIN,	V _{IL} = MAX,	I _{OH} = − 0.4 mA	2.5	3.4		2.7	3.4		٧
.,	VCC = MIN,	V _{1H} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 8 mA					0.35	0.5	,
l _l	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
ин	VCC = MAX,	V ₁ = 2.7 V				20			20	μΑ
l(L	V _{CC} = MAX,	V ₁ = 0.4 V	*			- 0.4			0.4	mA
IOS §	V _{CC} = MAX			- 20		- 100	20		- 100	mA
Іссн	V _{CC} = MAX.	V _I = 0 V			2	4		2	4	mΑ
lccr	VCC = MAX.	See Note 2			3.4	6.8		3.4	6.8	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	IDITIONS	MIN	TYP	MAX	UNIT
tPLH	A B == C	V	R _{I.} = 2 kΩ,	C 15 - C		10	15	пѕ
t _{PHL}	A, B or C	, r	n 2 ksz,	C _L = 15 pF		10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
JM38510/00404BCA	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
JM38510/30302B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30302B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30302BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30302BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30302BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30302BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SN5427J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN5427J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN54LS27J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS27J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN7427N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7427N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS27D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS27N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS27N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS27N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS27NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS27NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS27NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS27NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM



PACKAGE OPTION ADDENDUM

26-Sep-2005

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins F	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SNJ5427J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5427J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5427W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ5427W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ54LS27FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS27FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS27J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS27J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS27W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS27W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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